

Substitute Form PTO-1449 (Modified)	U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 00614-136002	Application No. 10/802,379
Information Disclosure Statement by Applicant (Use several sheets if necessary) (37 CFR §1.98(b))		Applicant Patrizio Vinciarelli	
		Filing Date March 17, 2004	Group Art Unit 2838

U.S. Patent Documents

Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
↑	AA	5,073,848	12/17/91	Steigerwald et al.	363	65	—
↓	AB	5,500,791	03/19/96	Kheraluwala et al.	363	17	—
↓	AC	5,576,940	11/19/96	Steigerwald et al.	363	17	—
↓	AD	5,726,849	03/10/98	Nakamura	361	93	—
↓	AE	5,861,738	01/19/99	Becker-Irvin et al.	323	282	—
↓	AF	6,069,811	05/30/00	Moriguchi et al.	363	142	—
↓	AG	6,310,792	10/30/01	Drobnik	363	147	—
↓	AH	6,583,999	06/24/03	Spindler et al.	363	98	—

Foreign Patent Documents or Published Foreign Patent Applications

Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation	
							Yes	No
↑	AI	EP 0550167	07/07/93	EP	H02M	3/335	—	—
↓	AJ	EP 0696831	02/14/96	EP	H02J	9/06	—	—
↓	AK	DE 19546936	06/19/97	Germany	H02M	3/28		X
↓	AL	WO 98/11658	03/19/98	WIPO	H02M	3/337		X
↓	AM	EP 0848485	06/17/98	EP	H02M	3/335	—	—
↓	AN	DE 19837639	03/02/00	Germany	H02H	7/10		X

Other Documents (include Author, Title, Date, and Place of Publication)

Examiner Initial	Desig. ID	Document
↑	AO	Brakus, B., "DC/DC Modules for Low Voltage Applications. The New Generation of Board Mounted Modules in Thick-Copper Multi-Layer Technology", IEEE, 1998, pp. 392-397.
↓	AP	Casey et al., "A High-Frequency, Low Volume, Point-of-Load Power Supply for Distributed Power Systems," IEEE Transactions on Power Electronics, Vol. 3, No. 1, January 1988.
↓	AQ	Hua et al., "Development of a DC Distributed Power System", IEEE, 1994, pp. 763-769.

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Examiner Signature <i>Stewart</i>	Date Considered 3/10/05
EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	